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Journal of Microelectronics, Electronic Components and Materials vol. 46, No. 1(2016)

Content | Vsebina

Original scientific paper		Izvirni znanstveni članki
S. Chtourou, E. Amouri, Z. Marrakchi, V. Pangracious, M. Abid, H. Mehrez: Exploration and Optimization of a Homogeneous Mesh of Clusters-Based FPGA Architecturesr	3	S. Chtourou, E. Amouri, Z. Marrakchi, V. Pangracious, M. Abid, H. Mehrez: Raziskava in optimizacija homogene mreže FPGA arhitekture na osnovi grozda
A. Hrovat, G. Kandus, U. Kuhar, A. Kelmendi, A. Vilhar: A Ka-band Satellite Beacon Receiver for Propagation Experiment	13	A. Hrovat, G. Kandus, U. Kuhar, A. Kelmendi, A. Vilhar: Satelitski sprejemnik v Ka frekvenčnem pasu za preizkus razširjanja radijskih valov
M. Milićević, B. Milinković, Đ. Simić, D. Grujić, L. Saranovac: Temperature and Process Compensated RF Power Detector	24	M. Milićević, B. Milinković, Đ. Simić, D. Grujić, L. Saranovac: Temperaturno in procesno kompenziran RF detector moči
M. Podhraški, J. Trontelj: An Integrated Microtransformer System for Displacement Measurement	29	M. Podhraški, J. Trontelj: Integriran mikrotransformatorski sistem za merjenje pomika
V. Macaitis, M. Jurgo, J. Charlamov, V. Barzdenas: A 3.0 – 3.6 GHz LC-VCO with ETSPC Frequency Divider in 0.18-micron CMOS technology	36	V. Macaitis, M. Jurgo, J. Charlamov, V. Barzdenas: 3.0 – 3.6 GHz LC-VCO z ETSPC frekvenčnim delilnikov v 0.18 mikronski CMOS tehnologiji
G. Ergaver, J. Trontelj: Prediction of Radiated Emissions of Automotive Electronics Early in the Design Phase based on Automotive Component Level Testing	42	G. Ergaver, J. Trontelj: Ocena nivojev sevalnih emisij avtomobilske elektronike v zgodnji fazi njenega razvoja na podlagi testiranja avtomobilskih komponent
Announcement and Call for Papers: 52 nd International Conference on Microelectronics, Devices and Materials With the Workshop on Biosensors and Microfluidics	53	Napoved in vabilo k udeležbi: 52. Mednarodna konferenca o mikroelektroniki, napravah in materialih z delavnico o biosenzorjih in mikrofluidiki
Front page: Test IC on a prototype PCB board. (M. Podhraški et al. , Photo: M. Hajdič)		Naslovnica: Testni čip na prototipni tiskanini. (M. Podhraški et al. , Foto: M. Hajdič)

Editorial | Uvodnik

Dear Reader,

This issue brings seven original scientific papers. Among them are the first few which were submitted through the on-line submission platform based on Open Journal System. We started with the on-line submission on 1st Jan 2016. Based on the first three month statistics with over 70 submissions we proudly report that the on-line system works well. We expect that the system will enable faster review times and higher satisfaction by authors.

This issue also bring the Call for paper at the 52nd MIDEM conference that the MIDEM Society organizes in Slovenia in late September every year. The conference will be organized in a picturesque hotel at the Adriatic seaside in the vicinity of town Koper. A highlight of the conference will be the Workshop on Biosensors and Microfluidics. The organizers invite you to join them at the inspiring invited talks and full three-day programme. Readers of the journal will get a chance to read selected papers from the conference in Issue 4 in December.

Page charges for papers published in the journal that were introduced in 2015 to cover publishing costs and to secure continuation of quality growth have been accepted with understanding. We noticed no decrease in submission rate. Implementing European open science / open access policy we will continue to provide a free electronic access to all papers published in *Informacije MIDEM* –Journal of Microelectronics, Electronics Components and Materials (since 1986).

We look forward to receiving your next manuscript(s) in our on-line submission platform: <u>http://ojs.midem-drustvo.si/index.php/InfMIDEM</u>

Enjoy reading the Issue 1/2016!

Prof. Marko Topič Editor-in-Chief

P.S.

All papers published in *Informacije MIDEM* –Journal of Microelectronics, Electronics Components and Materials (since 1986) can be access electronically for free at <u>http://midem-drustvo.si/journal/home.aspx</u>. A search engine is provided to use it as a valuable resource for referencing previous published work and to give credit to the results achieved from other groups.



Journal of Microelectronics, Electronic Components and Materials Vol. 46, No. 1 (2016), 53 – 53

MIDEM 2016

52nd INTERNATIONAL CONFERENCE ON MICROELECTRONICS, DEVICES AND MATERIALS WITH THE WORKSHOP ON BIOSENSORS AND MICROFLUIDICS



Announcement and Call for Papers

September 28th – 30th, 2016 Ankaran, Slovenia

ORGANIZER: MIDEM Society - Society for Microelectronics, Electronic Components and Materials, Ljubljana, Slovenia

CONFERENCE SPONSORS: Slovenian Research Agency, Republic of Slovenia; IMAPS, Slovenia Chapter; IEEE, Slovenia Section; Zavod TC SEMTO, Ljubljana.

GENERAL INFORMATION

The 52nd International Conference on Microelectronics, Electronic Components and Devices with the Workshop on Biosensors and Microfluidics continues a successful tradition of the annual international conferences organised by the MIDEM Society, the Society for Microelectronics, Electronic Components and Materials. The conference will be held at **Hotel Convent**, **Ankaran, Slovenia**, well-known resort and conference centre, from **SEPTEMBER 28th – 30th, 2016**.

Topics of interest include but are not limited to:

- Workshop focus: Biosensors and Microfluidics
- Novel monolithic and hybrid circuit processing techniques,
- New device and circuit design,
- Process and device modelling,
- Semiconductor physics,
- Sensors and actuators,
- Electromechanical devices, Microsystems and nanosystems,







- Nanoelectronics
- Optoelectronics,
- Photonics,
- Photovoltaic devices,
- New electronic materials and applications,
- Electronic materials science and technology,
- Materials characterization techniques,
- Reliability and failure analysis,
- Education in microelectronics, devices and materials.

ABSTRACT AND PAPER SUBMISSION:

Prospective authors are cordially invited to submit up to 1 page abstract before **May 1**st, **2016**. Please, identify the contact author with complete mailing address, phone and fax numbers and e-mail address.

After notification of acceptance (**June 15th, 2016**), the authors are asked to prepare a full paper version of six pages maximum. Papers should be in black and white. Full paper deadline in PDF and DOC electronic format is: **August 31st, 2016.**

IMPORTANT DATES:

Abstract deadline: **May 1**st, **2016** (1 page abstract or full paper)

Notification of acceptance: June 15th, 2016 Deadline for final version of manuscript: August 31st, 2016

Invited and accepted papers will be published in the conference proceedings.

Deatailed and updated information about the MIDEM Conferences is available at http://www.midem-drustvo.si/ under Conferences.

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